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***Abstract*— This document gives formatting instructions for authors preparing papers for publication in the Sisforma. The authors must follow the instructions given in the document for the papers to be published.**

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1. **I. INTRODUCTION**

Introduction contains background research, the purpose of research, review studies that have been conducted, the purpose of the study is also the need for this study?

Writing in the journal article using Time New Roman 12 pt with spaces 1, two columns, spacing between columns of 0.5 cm

A-4 size paper, a maximum of 5 pages.

**II. LITERATUR REVIEW**

Review of Literature contains the foundations of the theory used in the study

If there given its sub-indices 1, 2, 3, etc.

***II.1 Sub Title Review of Literature***

1. **III. Research Methodology**

Contains methods used in the studies that have been conducted

Captions and tables refer to the chapter headings and is written in TNR 10 pt Bold.

**Fig.3.1.......**

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**Table 3.1 ............**

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| **Font Size** | **Appearance (in Time New Roman or Times)** |
| **Regular** | Bold | **Italic** |
| 10 | table caption (in Caps), figure caption, reference item |  | reference item (partial) |
| 12 | author email address, cell in a table | abstract body | abstract heading (also in Bold) |

1. IV. Results and Discussion

Contains the results of research and discussion

1. V. Conclusions

Contains a summary of what was discussed above

**ACKNOWLEDGMENT**

The heading of the Acknowledgment section and the References section must not be numbered.

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